Unit: mm



TOSHIBA Diode Silicon Epitaxial Planar Type

## HN1D03FU

#### Ultra High Speed Switching Application

- AEC-Q101 Qualified (Note1)
- Built in anode common and cathode common.

Note1: For detail information, please contact our sales

#### Unit 1

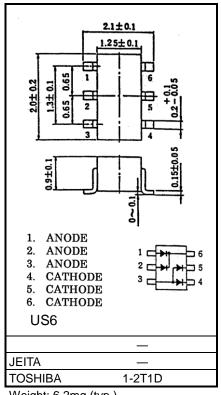
Low forward voltage Q1, Q2: V<sub>F</sub> (3) = 0.90 V (typ.)
 Fast reverse recovery time Q1, Q2: t<sub>rr</sub> = 1.6 ns (typ.)
 Small total capacitance Q1, Q2: C<sub>T</sub> = 0.9 pF (typ.)

Unit 2

Low forward voltage Q3, Q4: V<sub>F</sub> (3) = 0.92 V (typ.)
 Fast reverse recovery time Q3, Q4: t<sub>rr</sub> = 1.6 ns (typ.)
 Small total capacitance Q3, Q4: C<sub>T</sub> = 2.2 pF (typ.)

# Unit 1, Unit 2 Common Absolute Maximum Ratings ( $Ta = 25^{\circ}C$ )

Characteristic	Symbol	Rating	Unit
Maximum (peak) reverse voltage	V <sub>RM</sub>	85	V
Reverse voltage	VR	80	V
Maximum (peak) forward current	IFM	300 (*)	mA
Average forward current	lo	100 (*)	mA
Surge current (10 ms)	IFSM	2 (*)	Α
Power dissipation	P <sub>D</sub> (Note 4)	200	mW
Junction temperature	Tj (Note 2)	150	°C
	T <sub>j</sub> (Note 3)	125	
Storage temperature	T <sub>stg</sub> (Note 2)	−55 to 150	°C
	T <sub>stg</sub> (Note 3)	-55 to 125	



Weight: 6.2mg (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

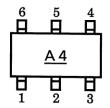
- Note 2: For devices with the ordering part number ending in LF(T.
- Note 3: For devices with the ordering part number in other than LF(T.
- Note 4: Total rating, Mounted on a FR4 board. (25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 0.32 mm<sup>2</sup> × 6).
  - (\*) These are the Absolute Maximum Ratings for a single diode (Q1 or Q2 or Q3 or Q4). If Unit 1 and Unit 2 are used independently or simultaneously, the Absolute Maximum Ratings per diode are 75% of those of a single diode.

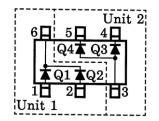
Start of commercial production 1992-05



#### Marking

#### **Pin Assignment (Top View)**





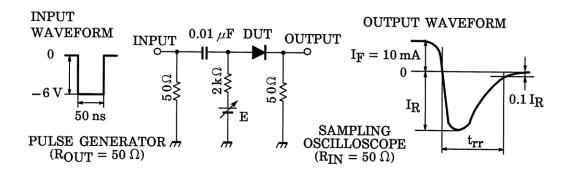


Fig.1 Reverse Recovery Time (t<sub>rr</sub>) Test Circuit

#### Unit 1 Electrical Characteristics (Q1, Q2 Common) (Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	VF (1)	_	IF = 1 mA	-	0.60		
	VF (2)	_	IF = 10 mA	ı	0.72		V
	VF (3)	_	IF = 100 mA	_	0.90	1.20	
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 30 V	_	_	0.1	μA
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 80 V	_	_	0.5	
Total capacitance	Ст	_	V <sub>R</sub> = 0 V, f = 1 MHz	_	0.9	3.0	pF
Reverse recovery time	t <sub>rr</sub>	_	IF =10 mA (fig.1)	_	1.6	4.0	ns

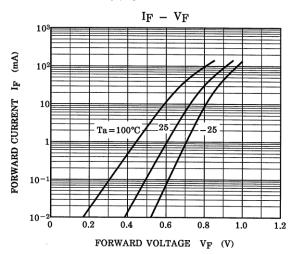
### Unit 2 Electrical Characteristics (Q3, Q4 Common) (Ta = 25°C)

Characteristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Forward voltage	VF (1)	_	I <sub>F</sub> = 1 mA	1	0.61		
	VF (2)	_	IF = 10 mA	1	0.74	1	V
	V <sub>F (3)</sub>	_	IF = 100 mA	_	0.92	1.20	
Reverse current	I <sub>R (1)</sub>	_	V <sub>R</sub> = 30 V	ı	-	0.1	μА
	I <sub>R (2)</sub>	_	V <sub>R</sub> = 80 V	1	_	0.5	
Total capacitance	Ст	_	V <sub>R</sub> = 0 V, f = 1 MHz		2.2	4.0	pF
Reverse recovery time	t <sub>rr</sub>	_	IF =10 mA (fig.1)	_	1.6	4.0	ns

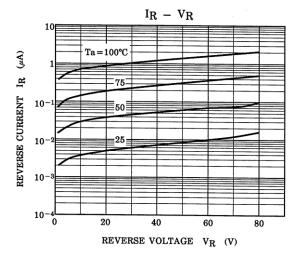


### **Characteristics Curves**

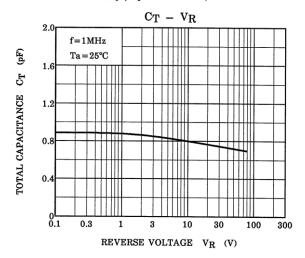
Unit 1 (Q1, Q2 COMMON)



Unit 1 (Q1, Q2 COMMON)



Unit 1 (Q1, Q2 COMMON)

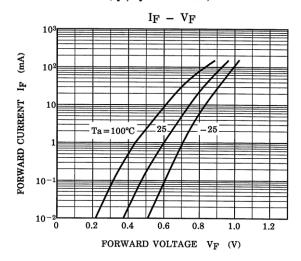


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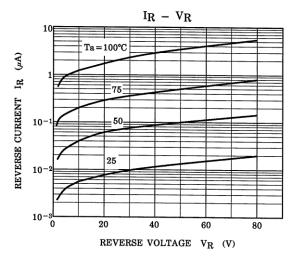


#### **Characteristics Curves**

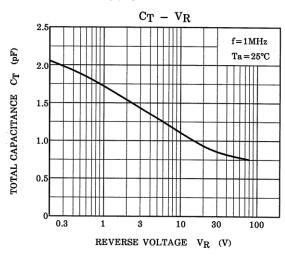
Unit 2 (Q3, Q4 COMMON)



Unit 2 (Q3, Q4 COMMON)



Unit 2 (Q3, Q4 COMMON)



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